

L Number	Hits	Search Text	DB	Time stamp
1	493	702/57.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:16
2	274	702/58.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:16
3	132	702/59.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:16
7	0	"laminograph and inspection and repair device using the same"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:26
12	5728	382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:26
14	0	5594768.pn. and segment\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:26
20	52	(segment\$3 divid\$3 division) near4 (PCB or (circuit near board\$1)) and (z-axis z-value (z near position\$1) z-plane)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:26
21	2	20030113009.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:26
25	869	(segment\$3 or divid\$3 or division) and (defect\$3 with (connect\$5)) and (pcb or (circuit near board\$1))	USPAT	2004/10/07 14:27
26	2232	segment\$3 with (electrical near connect\$5)	USPAT	2004/10/07 14:27
34	240	((segment\$3 or fragment\$3 divid\$3 or division) with (pcb or board\$1 or surface\$1)) and ((defect\$3 abnormal\$4) near5 ((electrical near connect\$4) or solder\$3))	USPAT; US-PGPUB	2004/10/07 14:27
35	0	0227117.9	EPO	2004/10/07 14:27
36	0	"02271179"	EPO	2004/10/07 14:27
39	5728	382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:27
41	508	(associat\$4 near3 defect\$3) with (segment\$4 section\$3 fragment\$3 area\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:28
42	0	power near collecting near plates	USPAT	2004/10/07 14:28
45	499	(segement\$3 divid\$4 seperat\$4 split\$4 fragment\$4 section\$4) with (board\$1 circuit\$1 pcb\$1 surface\$1) with (response respect based result\$3) with (defect\$4 or abnormal\$4)	USPAT	2004/10/07 14:28

48	0	("4926452" "5081656" "5097492" "5199054" "5259012" "5291535" "5561696" "5583904" "5621811" "5687209").pn. and (slope\$1)	USPAT	2004/10/07 14:28
49	0	("4926452" "5081656" "5097492" "5199054" "5259012" "5291535" "5561696" "5583904" "5621811" "5687209").pn. and (gradient\$1)	USPAT	2004/10/07 14:28
50	499	(segment\$3 divid\$4 seperat\$4 split\$4 fragment\$4 section\$4) with (board\$1 circuit\$1 pcb\$1 surface\$1) with (response respect based result\$3) with (defect\$4 or abnormal\$4)	USPAT	2004/10/07 14:28
51	5728	382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:28
52	3685	382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls. and 378/22.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:28
53	1067	(segment\$3 divid\$4 seperat\$4 split\$4 fragment\$4 section\$4) with (board\$1 circuit\$1 pcb\$1 surface\$1) with (response respect based result\$3) with (defect\$4 or abnormal\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:28
54	5850	382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls. 378/22.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:28
55	856341	(slope\$1 or gradient\$1 or pitch\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:28
57	36861	(determin\$6 calculat\$6 find\$3 analyz\$6) near2 (slope\$1 or gradient\$1 or pitch\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
59	14921	(determin\$6 calculat\$6 find\$3 analyz\$6) near2 (slope\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
4	10	("4926452" "5081656" "5097492" "5199054" "5259012" "5291535" "5561696" "5583904" "5621811" "5687209").pn.	USPAT	2004/10/07 14:29
5	1	6084663.pn.	USPAT	2004/10/07 14:29

15	1	5594768.pn. and divid\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
16	2	6665433.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
17	247	382/147.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
18	1	"6490368".PN.	USPAT	2004/10/07 14:29
19	32	(segment\$3 divid\$3 division) near2 (PCB or (circuit near board\$1)) and (z-axis z-value (z near position\$1) z-plane)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
22	1	((segment\$3 divid\$3 division) near4 (PCB or (circuit near board\$1)) and (z-axis z-value (z near position\$1) z-plane)) and 20030113009.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
23	1	6314201.pn.	USPAT	2004/10/07 14:29
24	2	("4942618" "5964487").pn.	USPAT	2004/10/07 14:29
27	59	(382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.) and ((segment\$3 or divid\$3 or division) and (defect\$3 with (connect\$5)) and (pcb or (circuit near board\$1)))	USPAT	2004/10/07 14:29
28	58	segment\$3 and ((defect\$3 abnormal\$5) near3 (electrical near connect\$5))	USPAT	2004/10/07 14:29
29	1	(segment\$3 with (electrical near connect\$5)) and (382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.)	USPAT	2004/10/07 14:29
30	118	(segment\$3 with board with (electrical near connection\$3))	USPAT; US-PGPUB	2004/10/07 14:29
31	7	382/147.ccls. and segmenting	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
32	178	((segment\$3 or divid\$3 or division) with board with (electrical near connection\$3))	USPAT; US-PGPUB	2004/10/07 14:29
33	3	((segment\$3 or divid\$3 or division) with board with (electrical near connection\$3) with (defect\$4 or abnormal\$4))	USPAT; US-PGPUB	2004/10/07 14:29
37	1	(mueller near horst) and (sunit near bhalla)	EPO	2004/10/07 14:29
38	1	(mueller near horst) and (sunit near bhalla)	EPO; DERWENT	2004/10/07 14:29
40	21	((segment\$3 or fragment\$3 divid\$3 or division) with (pcb or board\$1 or surface\$1)) and ((defect\$3 abnormal\$4) near5 ((electrical near connect\$4) or solder\$3))) and (382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:29
43	23	(382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.) and ((associat\$4 near3 defect\$3) with (segment\$4 section\$3 fragment\$3 area\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:30
44	2	power near collecting near plate	USPAT	2004/10/07 14:30
46	4	382/141.ccls. and fillet\$1	USPAT	2004/10/07 14:30

47	1	4926452.pn.	USPAT	2004/10/07 14:30
56	42	((segment\$3 divid\$4 seperat\$4 split\$4 fragment\$4 section\$4) with (board\$1 circuit\$1 pcb\$1 surface\$1) with (response respect based result\$3) with (defect\$4 or abnormal\$4)) and (382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls. 378/22.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:30
58	934	((slope\$1 or gradient\$1 or pitch\$1)) and (382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:30
60	155	((determin\$6 calculat\$6 find\$3 analyz\$6) near2 (slope\$1 or gradient\$1 or pitch\$1)) and (382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:30
61	50	((determin\$6 calculat\$6 find\$3 analyz\$6) near2 (slope\$1)) and (382/141,145,147,149,150.ccls. 348/86,87,125,126,129.ccls. 702/57-59.ccls. 356/237.1.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/07 14:30